Attorney Docket No.: 56937-027

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Group Art Unit: 2827

Takeshi SUZUKI, et al.

Serial No.: 09/890,145

Examiner: J.C. NORRIS

Filed: July 26, 2001

For: WIRING BOARD AND PRODUCTION METHOD THEREOF

AMENDMENT UNDER 37 C.F.R. §1.111

Hon. Assistant Commissioner for Patents Washington, DC 20231

Sir:

In response to the Office Action dated August 28, 2002, having a shortened statutory period for response set to expire November 28, 2002, a petition for extension of time up to and including December 28, 2002 being filed concurrently herewith, please amend the above-identified application as follows:

IN THE ABSTRACT:

Please amend the Abstract to read as follows:

--The present invention aims to provide a wiring substrate highly reliable in insulation and connection and a method for manufacturing the wiring substrate. A wiring substrate having two or more wiring layers, insulation layers interposed between the neighboring wiring layers and containing an organic resin, and a via formed in the

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